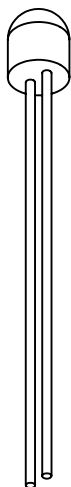
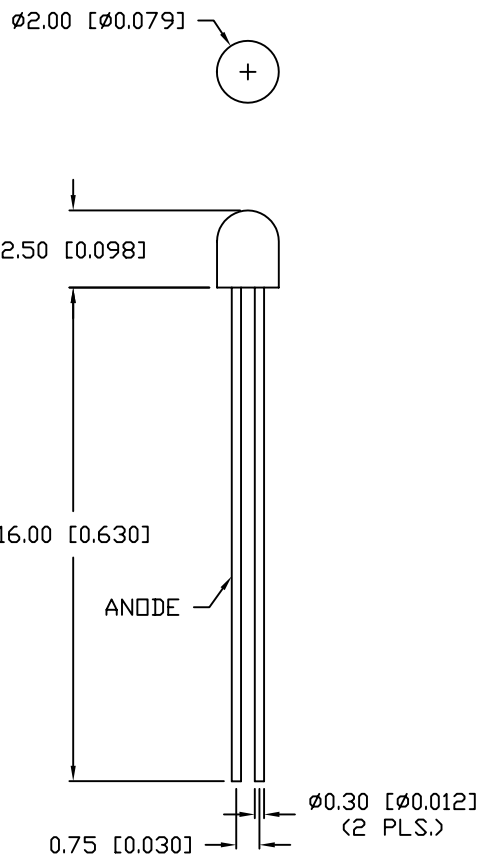


REV.	E.C.N. NUMBER AND REVISION COMMENTS	DATE
A	E.C.N. #10BRDR. & REDRAWN.	2.9.01
B	E.C.N. #11126.	5.13.04



ELECTRO-OPTICAL CHARACTERISTICS  $T_A=25^{\circ}\text{C}$   $I_f=20\text{mA}$

PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		565		nm	
FORWARD VOLTAGE		2.2	2.6	$V_f$	
REVERSE VOLTAGE	5.0			$V_r$	$I_r=100\mu\text{A}$
AXIAL INTENSITY		6		mcd	$I_f=20\text{mA}$
VIEWING ANGLE		160		2x theta	
EMITTED COLOR:	GREEN				
EPOXY LENS FINISH:	GREEN TRANSPARENT				

LIMITS OF SAFE OPERATION AT  $25^{\circ}\text{C}$

PARAMETER	MAX	UNITS
PEAK FORWARD CURRENT*	150	mA
STEADY CURRENT	25	mA
POWER DISSIPATION	105	mW
DERATE FROM $25^{\circ}\text{C}$	-1.6	mW/ $^{\circ}\text{C}$
OPERATING TEMP.	-25 TO +75	$^{\circ}\text{C}$
STORAGE TEMP.	-25 TO +100	$^{\circ}\text{C}$
SOLDERING TEMP.	+260	$^{\circ}\text{C}$
2.0mm FROM BODY		3 SEC. MAX

\*  $t < 10\mu\text{s}$

NOTES:

1. ANODE MARK IS INDICATED BY A SMALL MARKING ON THE SIDE OF THE CERAMIC SURFACE.

\*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X= $\pm 1$  ( $\pm 0.039$ ), X.X= $\pm 0.5$  ( $\pm 0.020$ ), X.XX= $\pm 0.25$  ( $\pm 0.010$ ), X.XXX= $\pm 0.127$  ( $\pm 0.005$ ). LEAD SIZE= $\pm 0.05$  ( $\pm 0.002$ ), LEAD LENGTH= $\pm 0.75$  ( $\pm 0.030$ ), MIN.=<sup>+DECIMAL PRECISION</sup>-0.00, MAX.=<sup>+0.00</sup>-DECIMAL PRECISION

REV. B	PART NUMBER SSL-LX203CGT
-----------	-----------------------------

**CONFIDENTIAL INFORMATION**  
THE INFORMATION CONTAINED IN THIS DOCUMENT IS THE PROPERTY OF LUMEX INC. EXCEPT AS SPECIFICALLY AUTHORIZED IN WRITING BY LUMEX INC., THE HOLDER OF THIS DOCUMENT SHALL KEEP ALL INFORMATION CONTAINED HEREIN CONFIDENTIAL AND SHALL PROTECT SAME IN WHOLE OR IN PART FROM DISCLOSURE AND DISSEMINATION TO ALL THIRD PARTIES.



290 E. HELEN ROAD  
PALATINE, IL 60067-6976  
PHONE: +1.847.359.2790  
US WEB: www.lumex.com  
TW WEB: www.lumex.com.tw

T-2 CERAMIC STEM LED,  
565nm GREEN LED, GREEN TRANSPARENT LENS.

**RELIABILITY NOTE**  
OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.

DRAWN BY: BC	CHECKED BY:	APPROVED BY:	DATE: 8.19.93
			PAGE: 1 OF 1
			SCALE: N/A